RENESAS

μ PA1932TE MOS FIELD EFFECT TRANSISTOR

Description

The μ PA1932TE is a switching device, which can be driven directly by a 4.5 V power source. The μ PA1932TE features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

Features

- V_{DS} Maximum ratings -30 V ($T_A = 25^{\circ}C$)
- 4.5 V drive available
- Low on-state resistance
 - --- $R_{DS(on)1} = 38 \text{ m}\Omega \text{ MAX.} (V_{GS} = -10 \text{ V}, I_D = -3.0 \text{ A})$
 - $R_{DS(on)2} = 59 \text{ m}\Omega \text{ MAX.} (V_{GS} = -4.5 \text{ V}, I_D = -3.0 \text{ A})$

Package Drawing (Unit: mm)

0.32 +0. 0.16+0.1 Drain 0.65[±] Body 2.8 ±0.2 Diode 1.5 1, 2, 5, 6 : Drain Gate 0 to 0.1 : Gate : Source Н +Gate Protection Source 0.65 0.95 0.95 Diode 0.4 1.9 0.9 to 1. 2.9 ± 0.2

Equivalent Circuit

Ordering Information

Part No.	Package
μ PA1932TE-T1-AT ^{Note}	SC-95 (Mini Mold Thin Type)
μ PA1932TE-T2-AT ^{Note}	

Note: This product does not contain Pb in external electrode and other parts.

"-T1", "-T2" indicates the unit orientation (8 mm embossed carrier tape, 3,000 p/reel).

Marking: UD

Absolute Maximum Ratings (T_A = 25°C)

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V_{GS} = 0 V)	V _{DSS}	-30	V
Gate to Source Voltage (V _{DS} = 0 V)	V _{GSS}	∓20	V
Drain Current (DC)	I _{D(DC)}	∓6.0	А
Drain Current (pulse) Note1	I _{D(pulse)}	∓24	А
Total Power Dissipation	P _{T1}	0.2	W
Total Power Dissipation Note2	P _{T2}	2.0	W
Channel Temperature	T _{ch}	150	°C
Storage Temperature	T _{stg}	-55 to + 150	°C
Single Avalanche Current Note3	I _{AS}	6.0	А
Single Avalanche Energy Note3	E _{AS}	3.6	mJ
Notes 1 PW \leq 10 μ s Duty Cycle \leq 1		1	

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

3. Starting T_{ch} = 25°C, V_{DD} = -15 V, R_G = 25 Ω , L = 100 μ H, V_{GS} = -20 \rightarrow 0 V



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^{2.} Mounted on a glass epoxy board of 2500 $\text{mm}^2\,\text{x}$ 1.6 mm , t \leq 5 sec

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

Caution for Electrostatic Discharge

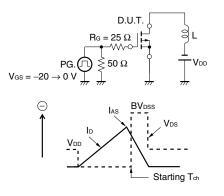
This product is electrostatic-sensitive device due to low ESD capability and should be handled with caution for electrostatic discharge. $V_{ESD} \pm 200 \text{ V TYP}$. (C = 200 pF, R = 0 Ω , Single pulse)

Electrical Characteristics (T_A = 25°C)

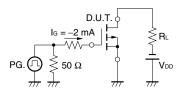
Item	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	
Zero Gate Voltage Drain Current	I _{DSS}			-1	μA	V_{DS} = -30 V, V_{GS} = 0 V	
Gate Leakage Current	I _{GSS}			∓10	μA	V _{GS} = ∓16 V, V _{DS} = 0 V	
Gate to Source Cut-off Voltage	V _{GS(off)}	-1.0	-1.6	-2.5	V	V_{DS} = -10 V, I_{D} = -1.0 mA	
Forward Transfer Admittance Note	y _{fs}	2.5	5.0		S	V_{DS} = -10 V, I_{D} = -3.0 A	
Drain to Source On-state Resistance Note	R _{DS(on)1}		30	38	mΩ	V_{GS} = -10 V, I _D = -3.0 A	
	R _{DS(on)2}		36	59	mΩ	V_{GS} = -4.5 V, I _D = -3.0 A	
Input Capacitance	Ciss		950		pF	V _{DS} = -10 V	
Output Capacitance	C _{oss}		210		pF	V _{GS} = 0 V	
Reverse Transfer Capacitance	C _{rss}		170		pF	f = 1.0 MHz	
Turn-on Delay Time	t _{d(on)}		11		ns	V_{DD} = -15 V, I _D = -3.0 A,	
Rise Time	t _r		10		ns	V _{GS} = -10 V,	
Turn-off Delay Time	t _{d(off)}		73		ns	$R_G = 6 \Omega$	
Fall Time	t _f		30		ns	-	
Total Gate Charge	Q _G		20		nC	V _{DD} = -24 V,	
Gate to Source Charge	Q _{GS}		2		nC	V _{GS} = -10 V,	
Gate to Drain Charge	Q _{GD}		6		nC	I _D = –6.0 A	
Body Diode Forward Voltage Note	V _{F(S-D)}		0.9		V	I_F = -6.0 A, V_{GS} = 0 V	
Reverse Recovery Time	t _{rr}		36		ns	$I_F = -6.0A, V_{GS} = 0 V,$	
Reverse Recovery Charge	Qrr		23		nC	di/dt = −100A/µ s	

Note: Pulsed

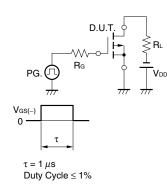
TEST CIRCUIT 1 AVALANCHE CAPABILITY

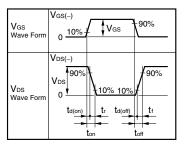


TEST CIRCUIT 3 GATE CHARGE



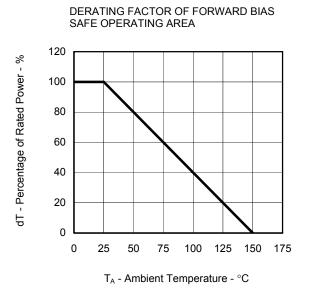
TEST CIRCUIT 2 SWITCHING TIME

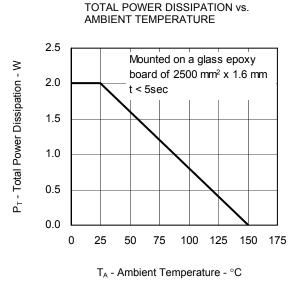




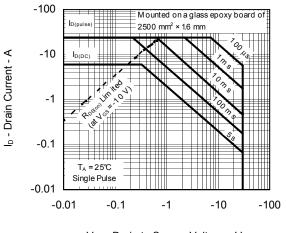


Typical Characteristics (T_A = 25°C)

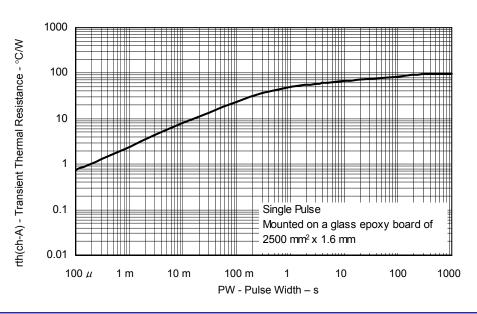




FORWARD BIAS SAFE OPERATING AREA



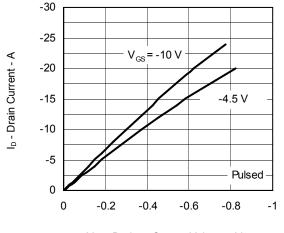
V_{DS} - Drain to Source Voltage - V



TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

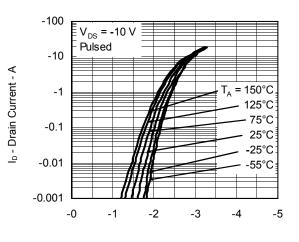


DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



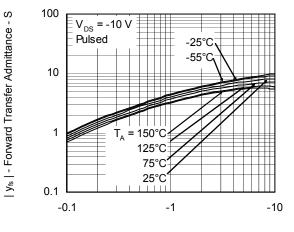
 V_{DS} - Drain to Source Voltage - V

FORWARD TRANSFER CHARACTERISTICS



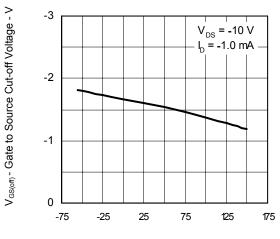
 $V_{\mbox{\scriptsize GS}}$ - Gate to Source Voltage - V

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

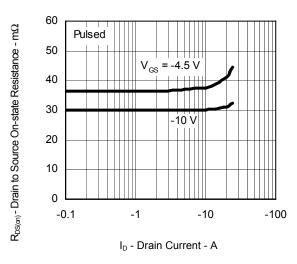


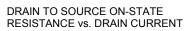
 $I_{\mbox{\scriptsize D}}$ - Drain Current - A



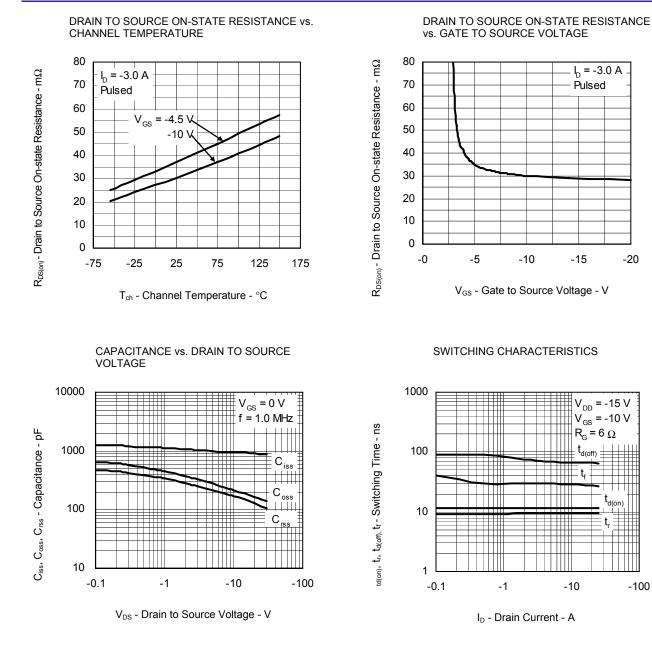


T_{ch} - Channel Temperature - °C

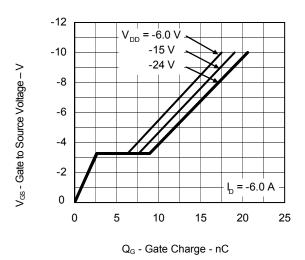




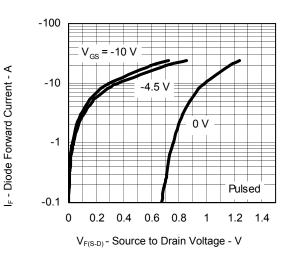




DYNAMIC INPUT CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE





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		Description		
Rev.	Date	Page	Summary	
1.00	May 31, 2010	-	First Edition issued	

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